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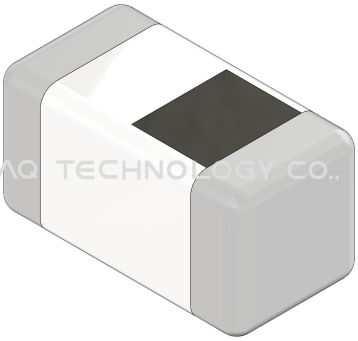
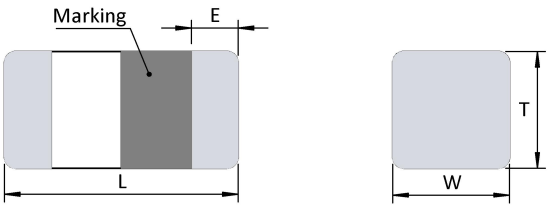
MCI1005HH33N_HBP

AEC-Q200 ROHS HF

外觀&形狀







L	1.00±0.10
W	0.50±0.10
T	0.50±0.10
E	0.20±0.10

(unit:mm)

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規格

長(公釐)	1.0±0.10
寬(公釐)	0.5±0.10
高(公釐)	0.5±0.10
尺寸代碼 英吋(公釐)	0402(1005)
感值(nH)	33
公差	G(±2%), H(±3%), J(±5%)
測試頻率(MHz)	100
最大值直流阻抗(Ω)	0.9
最大溫升電流(mA)	200
最小值品質因素	8
最小值自我諧振頻率(MHz)	1600
操作溫度℃	-55~+125

PASSIVE SYSTEM ALLIANCE
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特點

●Particular ceramic material and coil structure provide high frequency application range up to 10GHz.

●Small size and low profile.

●Available in various sizes.

●Excellent solderability and heat resistance.

包裝訊息

包裝尺寸(Inch)	包裝類型	標準包裝(PCS)	單重(gram)	濕敏等級
7	Paper type	10000	0.00069	1

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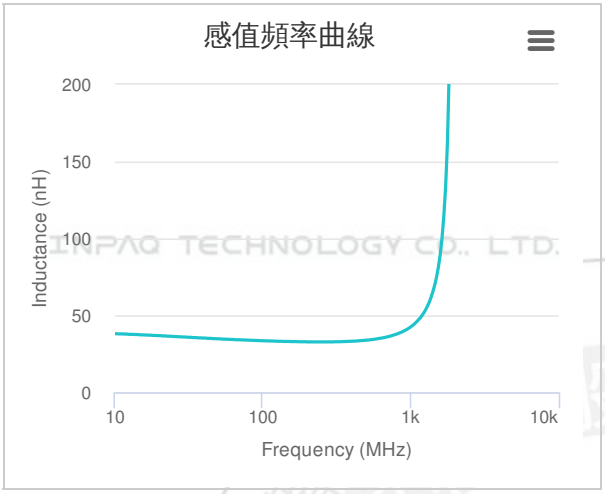
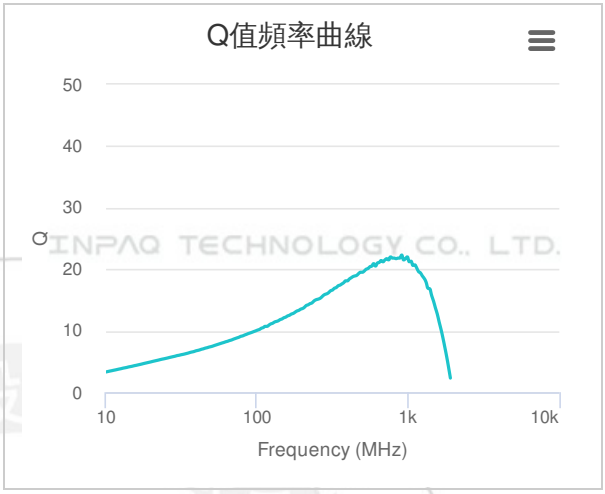
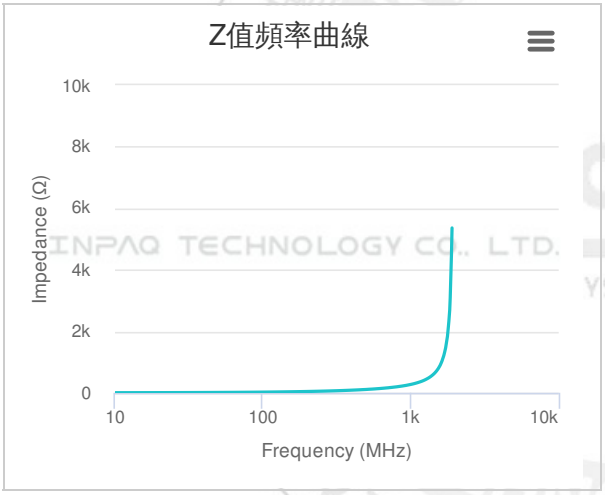
特性曲線







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